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Kind regards,

Team Nexperia

74LVC16241A

16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 26 October 2011

Product data sheet

1. General description

The 74LVC16241A is a 16-bit non-inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs (1OE, 2OE, 3OE and 4OE). Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer.

Inputs can be driven from either 3.3~V or 5~V devices. When disabled, up to 5.5~V can be applied to the outputs. These features allow the use of these devices in mixed 3.3~V and 5~V applications.

2. Features and benefits

- 5 V tolerant inputs and outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance outputs when V_{CC} = 0 V
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V
 - ◆ JESD8-5A (2.3 V to 2.7 V
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

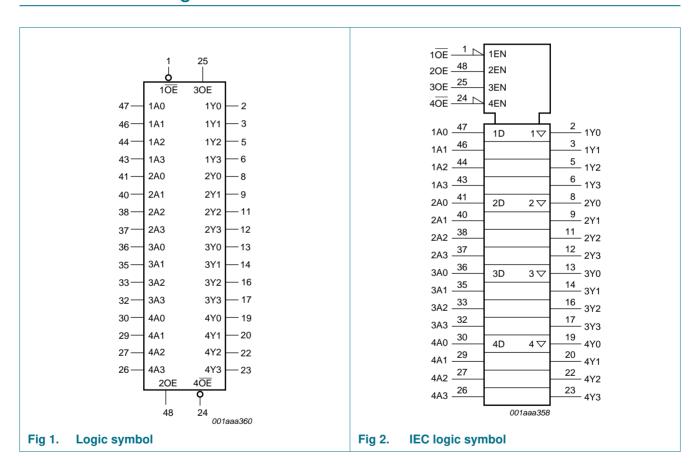


3. Ordering information

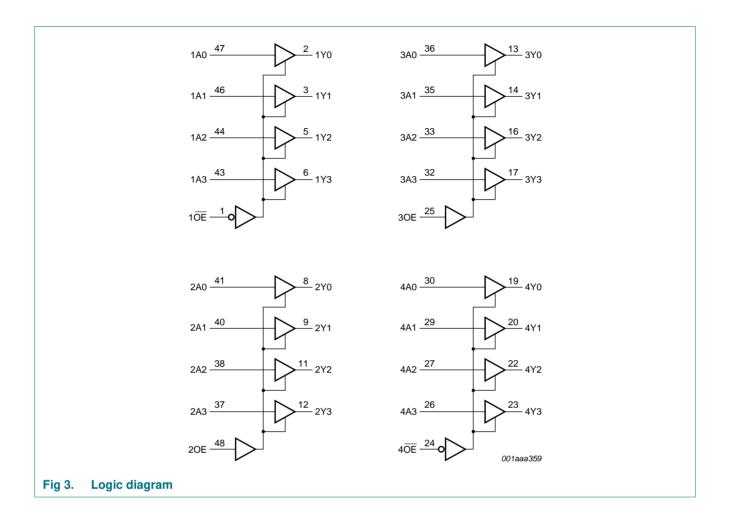
Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74LVC16241ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1				
74LVC16241ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1				

4. Functional diagram

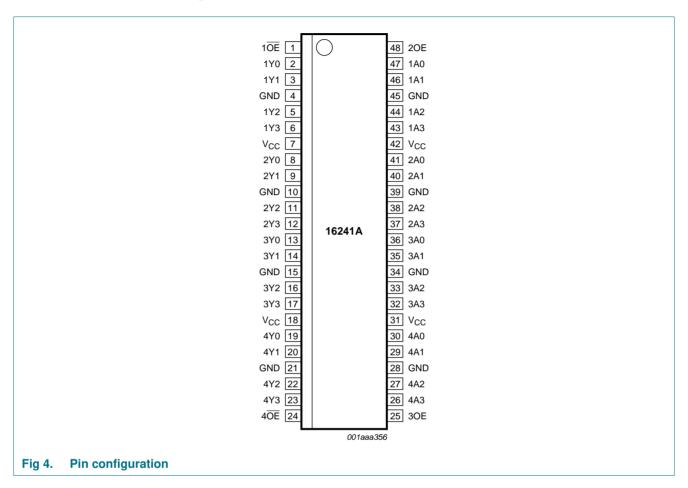


16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Name	Pin	Description
1 OE	1	output enable input (active LOW)
20E	48	output enable input (active HIGH)
30E	25	output enable input (active HIGH)
4 OE	24	output enable input (active LOW)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1Y[0:3]	2, 3, 5, 6	data output
2Y[0:3]	8, 9, 11, 12	data output
3Y[0:3]	13, 14, 16, 17	data output
4Y[0:3]	19, 20, 22, 23	data output
1A[0:3]	47, 46, 44, 43	data input

16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Table 2. Pin description ... continued

Name	Pin	Description
2A[0:3]	41, 40, 38, 37	data input
3A[0:3]	36, 35, 33, 32	data input
4A[0:3]	30, 29, 27, 26	data input

6. Functional description

Table 3. Function table[1]

Input	Output		
nAn	nOE	nOE	nYn
Н	L	-	Н
	-	Н	Н
L	L	-	L
	-	Н	L
X	Н	-	Z
	-	L	Z

^[1] H = HIGH voltage level

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
V_{I}	input voltage		<u>[1]</u>	-0.5	+6.5	V
I_{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$		-	±50	mA
V_{O}	output voltage	HIGH or LOW state	[2]	-0.5	$V_{CC} + 0.5$	V
		3-state	[2]	-0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I_{GND}	ground current			-100	-	mA
T_{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3]	-	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] Above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V _I	input voltage		0	-	5.5	V
V _O	output voltage	HIGH or LOW state	0	-	V_{CC}	V
		3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
** *	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	٧
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	٧
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	٧
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	٧
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	٧
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	٧
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	٧
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	8.0	٧
V _{OH} HIGH-level output voltage		$V_I = V_{IH}$ or V_{IL}						
		$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	$V_{\text{CC}}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	٧
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	٧
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	٧
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	٧
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	٧
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	٧
		$I_O = 8 \text{ mA}$; $V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	٧
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	٧
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	٧
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40) °C to +8	85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	20	-	80	μА
ΔI_{CC}	additional supply current	per inputpin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$	-	5	500	-	5000	μΑ
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	meter Conditions T		T _{amb} =	–40 °C to	+85 °C	–40 °C to	40 °C to +125 °C	
					Typ[1]	Max	Min	Max	
t _{pd}	propagation	nAn to nYn; see Figure 5	[2]		•	•	•		
	delay	V _{CC} = 1.2 V		-	13	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.7	4.8	10.1	1.7	11.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	2.6	5.3	1.5	6.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	2.6	5.0	1.0	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.2	4.4	1.0	5.5	ns
t _{en} enable tim	enable time	nOE to nYn; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	5.2	12.5	1.0	13.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.0	6.9	1.0	7.3	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.2	6.0	1.0	7.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.4	5.5	1.0	7.0	ns
		nOE to nYn; see Figure 7							
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.5	6.9	14.2	2.5	15.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.1	3.9	7.5	2.1	8.3	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.3	6.0	1.5	7.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.1	5.5	1.5	7.0	ns



 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{dis} disa	disable time	nOE to nYn; see Figure 6	[2]	•	•	•			
		V _{CC} = 1.2 V		-	9.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.4	4.3	8.3	2.4	9.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.4	4.7	1.0	5.2	ns
		V _{CC} = 2.7 V		1.5	3.2	5.5	1.5	7.0	ns
		V _{CC} = 3.0 V to 3.6 V		1.5	3.0	5.0	1.5	6.5	ns
		nOE to nYn; see Figure 7							
		V _{CC} = 1.2 V		-	8.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	3.5	8.4	1.5	9.6	ns
		V _{CC} = 2.3 V to 2.7 V		0.5	1.9	4.8	0.5	5.5	ns
		V _{CC} = 2.7 V		1.5	3.5	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.6	5.0	1.0	6.5	ns
C_{PD}	power	per input; $V_I = GND$ to V_{CC}	[3]						
	dissipation	V _{CC} = 1.65 V to 1.95 V		-	8.4	-	-	-	pF
	capacitance	V _{CC} = 2.3 V to 2.7 V		-	11.9	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V		-	15.0	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 t_{en} is the same as t_{PZL} and t_{PZH} .

t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

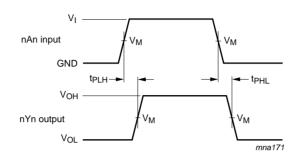
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs}$

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

11. Waveforms

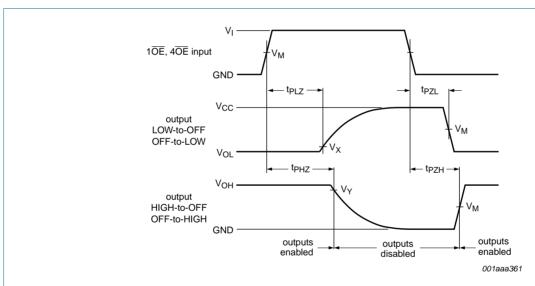


 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 \ V.$

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Input nAn to output nYn propagation delays Fig 5.



Measurements points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

3-state enable and disable times for inputs 10E and 40E Fig 6.

Table 8. **Measurement points**

Supply voltage	Input	Output		
V _{CC}	V _M	V _M	V _X	V _Y
1.2 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 V$
1.65 V to 1.95 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 V$	$V_{OH} - 0.15 V$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 V$	$V_{OH} - 0.15 V$
2.7 V	1.5 V	1.5 V	V_{OL} + 0.3 V	$V_{OH} - 0.3 V$
3.0 V to 3.6 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	V _{OH} – 0.3 V

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16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

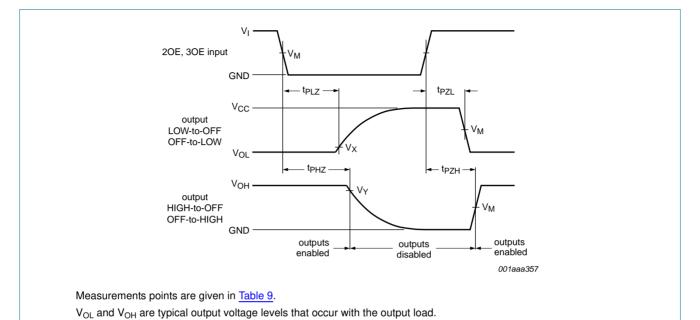
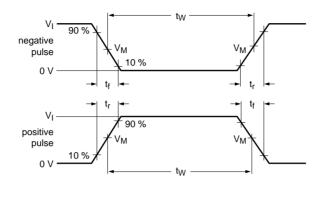
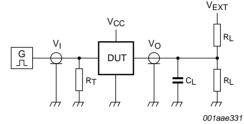


Fig 7. 3-state enable and disable times for inputs 20E and 30E

Table 9. Measurement points

Supply voltage	Input	Output		
V _{CC}	V _M	V _M	V _X	V _Y
1.2 V	$0.5 \times V_{CC}$	$0.5 \times V_{\text{CC}}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
1.65 V to 1.95 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$
3.0 V to 3.6 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$





Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

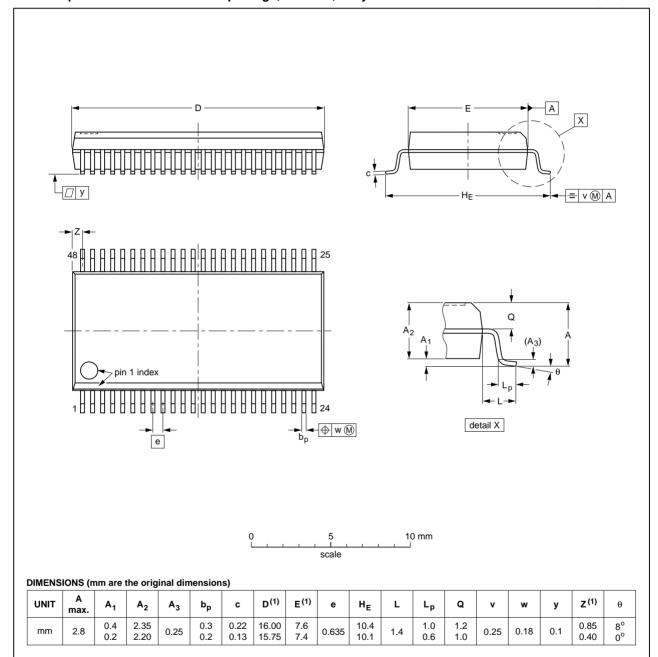
Table 10. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
	V _I	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND		

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT370-1		MO-118				99-12-27 03-02-19	

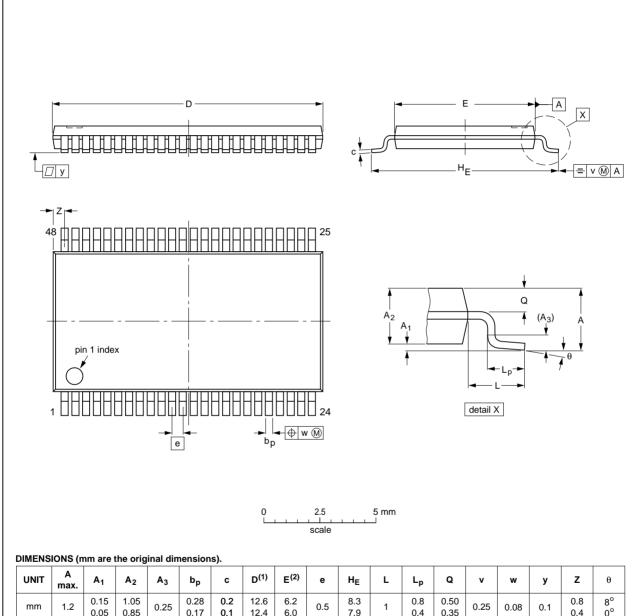
Fig 9. Package outline SOT370-1 (SSOP48)

74LVC16241A

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT362-1		MO-153				-99-12-27 03-02-19	

Fig 10. Package outline SOT362-1 (TSSOP48)

74LVC16241A

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13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74LVC16241A v.4	20111026	Product data sheet	-	74LVC16241A v.3				
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 							
	 Legal texts have been adapted to the new company name where appropriate. 							
	• Table 4, Table	5, Table 6, Table 7, and Table	e 10: values added for	lower voltage ranges.				
74LVC16241A v.3	20040305	Product specification	-	74LVC16241A v.2				
74LVC16241A v.2	19970729	Product specification	-	74LVC16241A v.1				
74LVC16241A v.1	19951226	Product specification	-	-				

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

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16. Contact information

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16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

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